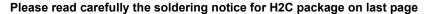
1.5-2.1GHz, 60W, GaN Fully matched PA Module

Description

The GMAH1521-60H2C is a 60-watt, single stage integrated Power Amplifier Module, designed For application with frequencies from 1.5 to 2.1GHz. When used at 32V, it can deliver 70W The module is 50 Ω input/output matched and requires minimal external components.





V DS - 28 V , V GS2.45 V , 1dq - 200 mA, C VV						
Freq(GHz)	Pin(dBm)	Pout(dBm)	Pout(W)	Ids(A)	Gain(dB)	Eff(%)
1.4	37.9	47.67	58.48	4.68	9.8	44.6
1.5	37.9	48.31	67.76	4.75	10.4	51.0
1.6	38.0	48.46	70.15	4.60	10.5	54.5
1.7	38.0	48.41	69.34	4.61	10.4	53.7
1.8	38.0	48.25	66.83	4.38	10.3	54.5
1.9	38.0	48.31	67.76	4.48	10.3	54.0
2.0	38.1	48.26	66.99	4.47	10.2	53.5
2.1	38.1	47.86	61.09	4.31	9.8	50.6
2.2	38.1	47.53	56.62	4.10	9.5	49.3

Product Features

- Operating Frequency Range: 1.5-2.1GHz
- Operating Drain Voltage(Recommended): +28V (Up to 32V)
- 50 Ω Input/Output (External DC block capacitor needed)
- Psat≥60W (CW)
- Small signal gain:>13dB, Power gain:>9dB
- Minimum Psat efficiency:>50%
- 18*17 mm metal RF package
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Applications

- Power Amplifiers within L band
- Test Instrumentation
- EMC Amplifier Drivers
- · 2-way Radios

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	$V_{\scriptscriptstyle DSS}$	150	Vdc
GateSource Voltage	V_{GS}	-10 to +2	Vdc
Operating Voltage	V_{DD}	+32	Vdc





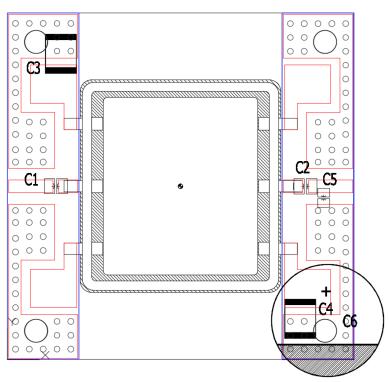
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Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	Τ _J	+225	°C

Table 2. Thermal Characteristics

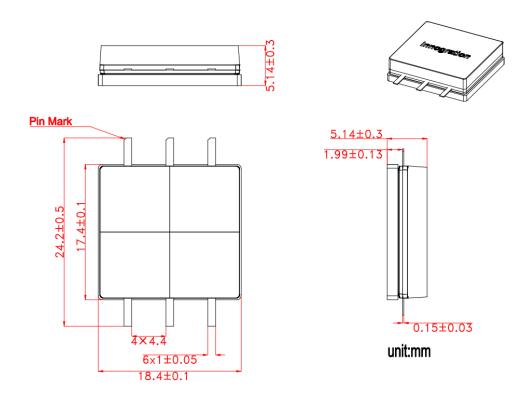
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	RеJC	2.4	°C/W
T _C = 25°C, Pout=60W, FEA		2.4	

Typical application circuit



Component	Description	Suggestion
C6	470uF/63V	
C3, C4	10uF	1210
C1, C2	2.7pF	.MQ100805
C5	0.1pF	MQ100603
РСВ		Rogers 4350B , Er = 3.48, thickness 20 mils,

Package Dimensions (Unit:mm)



When soldering, the temperature of the iron tip must be below 220°C. The contact time between the iron tip and the pins should be as short as possible, not exceeding 10 seconds. The number of repeated soldering operations must not exceed 3 times. Otherwise, it may damage the bond between the ACP lead frame and the pins, resulting in failure of the component's sealing performance.

Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2025/7/5	Rev 1.0	Advanced Datasheet

Application data based on YHG-25-21

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